Overview

HP ZBook Firefly 14" G9 Mobile Workstation PC



- 1. Ambient Light Sensor (Optional)
- 2. Internal Microphones (2)
- 3. Webcam LED (Optional)
- 4. Webcam
- 5. Camera Shutter
- 6. IR Camera (Optional)
- 7. IR Camera LEDs (Optional)

Right

- 8. Clickpad
- 9. Power Button Key
- 10. Audio Combo Jack
- 11. SuperSpeed USB Type-A 5Gbps signaling rate
- 12. Nano Security Lock Slot (Lock sold separately)
- 13. SIM Card Slot (Optional)
- 14. Touch Fingerprint Sensor (Select models)



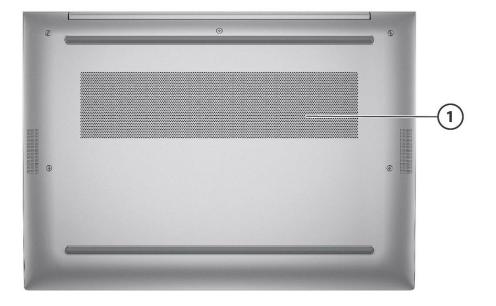
Overview



Left

- 1. HDMI 2.0b Port (Cable not included)
- 2. SuperSpeed USB Type-A 5Gbps signaling rate (Charging)
- 2 Thunderbolt[™] 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)1
- 4. LED Indicator
- 5. Smartcard Reader (Optional)

Overview



Bottom

1. Fan Venting



Overview

At A Glance

- New premium ultraslim design with precision-crafted all-metal chassis for a premium look and feel
- 12th Generation Intel[®] Core[™] i5, i7 U series and i5, i7 P series Processors up to fourteen-core
- Preinstalled with Windows 11 versions or FreeDOS
- New 16:10 ratio screen reduces the need to scroll by showing more vertical content than 16:9
- New 5MP camera² with HP Auto Frame¹ allows you around a little without losing viewers' attention during video calls
- New DDR5 memory and PCI Gen4 SSDs provide fast access to your work.
- Choice of displays:

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- 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit, 250 nits, 45% NTSC
- 35.6cm (14") diagonal WUXGA IPS Anti-Glare On-Cell LED-backlit touch, 250 nits, 45% NTSC
- 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch 400 nits, 100% sRGB
- 35.6cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch, 1000 nits, 100% sRGB with HP Sure View Reflect
- Redesigned keyboard layout to include easy use of discrete PgUp/Dn, End, and Home keys
- Choose from 38Whr or 51Whr battery options
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense.⁵
- Larger Clickpad surface for easier, more intuitive input
- Connectivity with optional Intel[®] 5000 5G/WWAN available world-wide, and Thunderbolt[™] Docking (Dock sold separately)
- Passes 19 MIL-STD 810H tests⁶
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles³
- Designed to support all HP docking options including the HP Universal Dock G5

¹Requires the myHP application and Windows OS.

²Optional feature that must be configured at the time of purchase.

³HP Presence requires myHP application and Windows OS.

⁴Requires Windows OS.

⁵HP Wolf Security for Business requires Windows 10 and higher, includes various HP security features and is available on HP Pro, Elite, Workstation, and RPOS products. See product details for included security features and OS requirements.

⁶MIL-STD 810GH is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

⁷SuperSpeed USB 20Gbps is not available with Thunderbolt[™] 4.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

OPERATING SYSTEM

Preinstalled OS

Windows 11 Pro - HP recommends Windows 11 Pro for business ² Windows 11 Pro Education ² Windows 11 Home - HP recommends Windows 11 Pro ² Windows 11 Home Single Language - HP recommends Windows 11 Pro ² Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade)^{1,2,3} FreeDOS

¹ Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

³This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

PROCESSOR

12th Generation Intel[®] Core[™] i7-1280P (1.3 GHz E-core base frequency, 1.8 GHz P-core base frequency, up to 3.6 GHz E-core Max Turbo Frequency, up to 4.8 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 Threads) Supporting Intel[®] vPro[®] technology ^{1,2,3,4,5}

12th Generation Intel[®] Core[™] i7-1270P (1.6 GHz E-core base frequency, 2.2 GHz P-core base frequency, up to 3.5 GHz E-core Max Turbo Frequency, up to 4.8 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 18 MB L3 cache, 4 P-cores and 8 E-cores, 16 Threads) Supporting Intel[®] vPro[®] technology ^{1,2,3,4,5}

12th Generation Intel[®] Core[™] i7-1260P (1.5 GHz E-core base frequency, 2.1 GHz P-core base frequency, up to 3.3 GHz E-core Max Turbo Frequency, up to 4.4 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 18 MB L3 cache, 4 P-cores and 8 E-cores, 16 Threads)^{1,2,3,4}

12th Generation Intel[®] Core[™] i5-1250P (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.3 GHz E-core Max Turbo Frequency, up to 4.4 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 12 MB L3 cache, 4 P-cores and 8 E-cores, 16 Threads) Supporting Intel[®] vPro[®] technology ^{1,2,3,4,5}

12th Generation Intel[®] Core[™] i5-1240P (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.3 GHz E-core Max Turbo Frequency, up to 4.4 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 12 MB L3 cache, 4 P-cores and 8 E-cores, 16 Threads)^{1,2,3,4}

12th Generation Intel[®] Core[™] i7-1265U (1.3 GHz E-core base frequency, 1.8 GHz P-core base frequency, up to 3.6 GHz E-core Max Turbo Frequency, up to 4.8 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 12 MB L3 cache, 2 P-cores and 8 E-cores, 12 Threads) Supporting Intel[®] vPro[®] technology ^{1,2,3,4,5}

12th Generation Intel[®] Core[™] i7-1255U (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.5 GHz E-core Max Turbo Frequency, up to 4.7 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 12 MB L3 cache, 2 P-cores and 8 E-cores, 12 Threads)^{1,2,3,4}



Features

12th Generation Intel[®] Core[™] i5-1245U (1.2 GHz E-core base frequency, 1.6 GHz P-core base frequency, up to 3.3 GHz E-core Max Turbo Frequency, up to 4.4 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 12 MB L3 cache, 2 P-cores and 8 E-cores, 12 Threads) Supporting Intel[®] vPro[®] technology ^{1,2,3,4,5}

12th Generation Intel[®] Core[™] i5-1235U (0.9 GHz E-core base frequency, 1.3 GHz P-core base frequency, up to 3.3 GHz E-core Max Turbo Frequency, up to 4.4 GHz P-core Max Turbo frequency with Intel[®] Turbo Boost Technology, 12 MB L3 cache, 2 P-cores and 8 E-cores, 12 Threads)^{1,2,3,4}

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

² Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
 ³ Intel[®] Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

⁴ In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

⁵ Intel vPro[®] requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro[®] Essentials and Enterprise vary. See http://intel.com/vpro



Features

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel[®] Iris[®] Xe Graphics ^{1, 3, 4, 5, 6}

Discrete

NVIDIA® T550 Laptop GPU (4 GB GDDR6 dedicated)^{2, 4}

NVIDIA RTX[™] A500 Laptop GPU (4 GB GDDR6 dedicated)^{2,4}

Supports

Support HD decode, DX12, HDMI 2.0b, HDCP 2.3

¹ UHD content required to view UHD images.

² Both UMA & Discrete configurations support 4 independent displays when on the HP Thunderbolt Dock G2 (120W) (sold separately) - Max. resolution = 2.5K @60Hz (DP1) & 2.5K @60Hz (DP2) & FHD (VGA) OR 4K @60Hz (one DP Port) & 4K @60Hz (Type-C output port using a Type C-to-DP adapter).

³ Support HD decode, DX12, HDMI 2.0b, HDCP 2.3 via DP up to 4K @ 60Hz and via HDMI up to 4096x2304 @ 60Hz

⁴ HDMI cable Sold Separately

⁵ Shared video memory (UMA) uses part of the total system memory for video performance. System memory dedicated to video performance is not available for other use by other programs.

⁶ Intel[®] Iris[®] Xe Graphics capabilities require system to be configured with Intel[®] Core[™] i5 or i7 processors and dual channel memory. Intel[®] Iris[®] Xe Graphics with Intel[®] Core[™] i5 or 7 processors and single channel memory will only function as UHD graphics.

DISPLAY

Non-touch

- 14" diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP camera (1920 x 1200)
- 14" diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera (1920 x 1200)
- 14" diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for WWAN (1920 x 1200)
- 14" diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP camera for WWAN (1920 x 1200)
- 14" diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera for WWAN (1920 x 1200)
- 14" diagonal WUXGA Bent, anti-glare UWVA eDP1.2, micro-edge, 250 nits, 45% NTSC, Narrow Bezel (1920 x 1200)
- 14" diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor for 5MP Camera (1920 x 1200)
- 14" diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor for 5MP+IR Camera (1920 x 1200)
- 14" diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor for 5MP+IR Camera for WWAN (1920 x 1200)
- 14" diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor for 5MP camera (1920 x 1200)
- 14" diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor for 5MP+IR camera (1920 x 1200)
- 14" diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor for 5MP+IR camera for WWAN (1920 x 1200)



Features

- 14" diagonal WQXGA Bent, anti-glare UWVA eDP 1.4+PSR, 500 nits, 100% HP DreamColor for 5MP Webcam + IR camera Narrow Bezel (2560 x 1600)
- 14" diagonal WQXGA Bent, anti-glare UWVA eDP 1.4+PSR, 500 nits, 100% HP DreamColor for 5MP Webcam + IR Camera for WWAN Narrow Bezel(2560 x 1600)
- 14" diagonal WUXGA Bent, Low Power, Low Blue Light, anti-glare UWVA eDP 1.4+PSR, 400 nits, 100% sRGB for 5MP Webcam for WWAN (1920x1200)

Touch

- 14" diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera Touch on Panel (1920 x 1200)
- 14" diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera for WWAN Touch on Panel (1920 x 1200)

DisplayPort™ 1.4

Support resolution up to 8K @60 Hz

Displays support

Supports up to 4 displays max through dock

¹HD content required to view HD images.

²Sold separately or as an optional feature.

³Resolutions are dependent upon monitor capability, and resolution and color depth settings.

⁴HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

⁵Actual brightness will be lower with touchscreen or Sure View.



Features

DOCKING

Docking station model #1	HP Thunderbolt Dock G2
Total number of supported displays (incl.the notebook) display)	4
Max.resolutions supported	Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported Single 8K@ 30Hz (multiple tiles) for Thunderbolt hosts Non-TBT hosts DP 1.4 in high res mode(1) 8K video single cable@30Hz
Dock Connectors	2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode
Technical limitations	 Thunderbolt Hosts: Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host. Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in High Resolution mode @30Hz Non-Thunderbolt hosts: The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is (1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.
Docking station model #2	HP USB-C Dock G5
Total number of supported displays (incl.the notebook) display)	3
Max.resolutions supported	Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode)
Dock Connectors	1xHDMI, 2xDP
Technical limitations	Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode. Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.
Docking station model #3	HP USB-C/A Universal Dock G2
Total number of supported displays (incl.the notebook) display)	3
Max.resolutions supported	Triple 4K UHD@ 60Hz
Dock Connectors	1xHDMI, 2xDP
Technical limitations	The best resolution for dual or triple displays is 4K UHD@ 60Hz. For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host



Features

STORAGE AND DRIVES*

PCIe[®] NVMe[™] M.2 2280 Storage

2 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 1 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 512 GB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 512 GB PCIe[®] Gen4x4 NVMe[™] SED TLC OPAL2 512 GB PCIe[®] NVMe[™] Value M.2 SSD 256 GB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 256 GB PCIe[®] Gen4x4 NVMe[™] SED TLC OPAL2 256 GB PCIe[®] NVMe[™] Value M.2 SSD

NOTE: Intel® Optane[™] H10 memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core[™] processor, BIOS version with Intel® Optane[™] supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of disk is reserved for system recovery software.

DRIVE CONTROLLERS

M.2 Storage Bay (PCIe NVMe) RAID: Supports up to PCIe[®] Gen4 x4 lanes NVMe[™] Solid State Drive Not supported

MEMORY

Maximum Memory 64GB DDR5-4800 Memory 64GB DDR5-4800 (2x32GB) 48GB DDR5-4800 (1x32GB+1x16GB) 32GB DDR5-4800 (2x16GB) 32GB DDR5-4800 (1x32GB) 16GB DDR5-4800 (1x16GB) 8GB DDR5-4800 (1x8GB)

Memory Slots

2 SODIMM DDR5 SODIMMS, system runs at 4800 MT/s Supports Dual Channel Memory



Features

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX211 Wi-Fi6E+BT5.3 M.2 1216 160MHz CNVi World-Wide WLAN wireless card vPro Intel® AX211 Wi-Fi6E+BT5.3 M.2 1216 160MHz CNVi World-Wide WLAN wireless card non-vPro Intel® AX211 Wi-Fi6E+BT5.3 M.2 2230 160MHz CNVi World-Wide WLAN wireless card vPro Intel® AX211 Wi-Fi6E+BT5.3 M.2 2230 160MHz CNVi World-Wide WLAN wireless card non-vPro

¹Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, and Windows 11 to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

WWAN¹

Intel® 5000 5G Solution WWAN³ Intel® XMM 7560 R+ LTE-Advanced Pro WWAN(Cat 16)²

¹Mobile Broadband is an optional feature, Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE is not available on all products, in all regions.

²4G LTE module is optional, must be configured at the factory, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

³Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

Near Field Communication (NFC) module

No Near Field Communication (NFC) module NFC Mirage WNC XRAV-1 **Miracast** Native Miracast Support

NOTE: Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen 2 Integrated stereo speakers Discrete Amplifiers Integrated dual array microphone

Speaker Power 2W/4ohm Per speaker

Camera^{1, 2} 5 MP camera



Features

5 MP+IR camera

Sensors

ALS (ambient light sensor) Magnetometer Hall Sensor Gyro Accelerometer HP Tamper Lock³

¹ HD content required to view HD images.

² Windows Hello face authentication utilizes a camera specially configured for near infrared (IR) imaging to authenticate and unlock Windows devices as well as unlock your Microsoft Passport.
 ³ HP Tamper Lock must be enabled by the customer or your administrator.



Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard*

HP Premium Keyboard, spill resistant, Backlit keyboard and DuraKeys HP Premium Keyboard, spill resistant, Non-Backlit keyboard and DuraKeys HP Premium Keyboard, spill resistant, Backlit keyboard and DuraKeys Privacy

Pointing Devices

Clickpad with multi-touch gesture support, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

Function Keys

- ESC: system information
- F1 Display Switching F2 - Blank or Privacy F3 - Brightness Down F4 - Brightness Up F5 - Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Airplane Mode
- F12 HP Command Center
- home
- end
- Power Button (with LED)

delete

- **Hidden Keys** Fn+R - Break Fn+S - Sys Rq
- Fn+C Scroll Lock

*Backlit keyboard is an optional feature.

SOFTWARE AND SECURITY

Software

HP Quick Touch HP Quick Drop²¹ **HP Easy Clean HP PC Hardware Diagnostics Windows HSA Fusion for Commercial** HSA Telemetry for Commercial **Touchpoint Customizer for Commercial myHP** HP Smart Support²⁴ HP Connection Optimizer¹⁰ HP Mac Address Manager **HP Hotkey Support** HP Support Assistant¹ **HP** Notifications **HP Privacy Settings HP Power Manager** Buy Microsoft Office (Sold separately)

Features

HP audio Control³³

Manageability Features

HP Connect for Microsoft Endpoint Manager²⁶ HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)¹² HP Client Management Script Library (download) HP Patch Assistant (download)²⁷ HP Driver Packs (download) HP Cloud Recovery ²⁸ HP Client Catalog (download)

Security Management

HP Wolf Security of Business ²⁹ includes: HP Sure Click ³⁰ HP Sure Sense¹⁹ HP Sure Run Gen5³¹ HP Sure Recover Gen5¹⁴ HP Sure Start Gen7¹⁶ HP Tamper Lock HP Sure Admin²³ HP Client Security Manager Gen7¹⁸

BIOS

HP BIOSphere Gen6⁶ HP Secure Erase¹⁷ Absolute Persistence Module⁷ HP DriveLock & Automatic DriveLock BIOS Update via Network HP Wake on WLAN HP Fingerprint Sensor³² Secured-Core PC Enable²⁰ TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

¹ HP Support Assistant - Requires Windows and Internet Access.

⁶ HP BIOSphere Gen6 is available on select HP Pro, Elite and ZBook PCs. See product specifications for details. Features may vary depending on the platform and configurations.

⁷ Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

¹⁰ HP Connection Optimizer requires Windows 10 and Windows 11.

¹² HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

¹⁴ HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

¹⁵ HP Sure Recover with Embedded Reimaging Gen3 is an optional feature which must be configured at purchase with a base unit that has the On System Recovery (OSR) module. See product specifications for availability You must back up important files, data, photos, videos, etc. before use to avoid loss of data. HP Sure Recover with Embedded Reimaging (Gen1) does not support platforms with Intel[®] Optane[™].
¹⁶ HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

¹⁷ HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel[®] Optane[™].



Features

¹⁸ HP Client Security Manager Gen7 requires Windows and is available on select HP Pro, Elite and ZBook PCs. See product specifications for details.

¹⁹ HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS. ²⁰ Secured-core PC requires an Intel[®] vPro[®] or AMD Ryzen[™] Pro processor. Requires 8 GB or more system memory. Secured-core PC functionality can be enabled from the factory.

²¹ Requires Internet access and Windows 10 PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

²³ HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

²⁴ HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: http://www.hp.com/smart-support. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

²⁶ HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.
²⁷ HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

²⁸ HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel[®] or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.

²⁹ HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

³⁰ HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

³¹ HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

³² HP Fingerprint Reader is an optional feature that requires Windows 10 IoT and must be configured at purchase.

³³ Microphone Noise Reduction and Speaker Noise Reduction feature included under HP Audio Control



Features

POWER

Power Supply

HP Smart 65 W USB Type-C[®] adapter HP Smart 45 W USB Type-C[®] adapter³

Battery⁴

HP Long Life 3-cell, 51 Wh Polymer

Power Cord² 3-wire plug - 1m 2-wire plug - 1m

Battery life¹ Up to 13 hrs

¹ Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark18 battery benchmark https://bapco.com/products/mobilemark-2018/ for additional details.

² Supports HP Fast Charge Technology

³45W Power Adapter is not available with Discrete Graphics Configurations.

⁴ Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

ENVIRONMENTAL

ENERGY STAR® certified EPEAT® 2019 registered where applicable. EPEAT® registration varies by country. See www.epeat.net for registration status by country. EPEAT® 2019 Gold TCO 8.0 Certified RCTA DO-160G Medical EMC: IEC 60601-1-2:2014 EN60601-1-2: 2015 SEPA GS Mark Eyesafe Certification - Worldwide

Sustainable Impact Specifications

Recycled Aluminum and Magnesium, 75% PCR w/30% ITE plastics

¹ Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. Status varies by country. Visit www.epeat.net for more information.

² External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.



Features

WEIGHTS & DIMENSIONS

Dimensions (w x d x h) 12.42 x 8.82 x 0.76 in 31.56 x 22.405 x 1.92 cm

Weights* Product Weight- 51Whr Starting at 3.17 lb Starting at 1.439 kg

*Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

2 Thunderbolt[™] 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)

2 Super Speed USB Type-A 5Gbps signaling rate (1 charging)

1 HDMI 2.0

- 1 Headphone/microphone combo jack
- 1 Nano Security Lock Slot (Lock sold separately)
- 1 Smartcard reader (Optional)
- 1 nano SIM card slot (Optional)

*SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4. *HDMI cable sold separately.

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

¹Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power) System in idle mode



Features

	Max Operating Power	65W
Temperature	Operating	32° to 95° F (0° to 35° C)
	Non-operating	41° to 95° F (5° to 35° C) (writing optical)
Relative Humidity	Operating	10% to 90%, non-condensing
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	Operating	40 G, 2 ms, half-sine
	Non-operating	200 G, 2 ms, half-sine
Random Vibration	Operating	0.75 grms
	Non-operating	1.50 grms
Maximum Altitude	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
(unpressurized)	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry Standard	Regulatory Model	HSN-145C-3
Certifications	Number	
	UL	Yes
	CSA	Yes
	FCC Compliance	Yes
	ENERGY STAR®	Certified ¹
	EPEAT [®]	EPEAT 2.0 Gold ²
	ICES	Yes
	Australia / NZ A-Tick Compliance	Yes
	כככ	Yes
	Japan VCCI Compliance	Yes
	КСС	Yes
	BSMI	Yes
	CE Marking Compliance	Yes
	MIL STD 810H	Yes, 19 tests
	BNCI or BELUS	Yes
	CIT	Yes
	EAC	Yes
	Saudi Arabian Compliance (ICCP)	Yes
	SABS	Yes
1Configurations of the UD 7Dee		ericetation DC that are ENEDCV CTAD® qualified are identified as HD

¹Configurations of the HP ZBook Firefly 14" G9 Mobile Workstation PC that are ENERGY STAR® qualified are identified as HP ZBook Firefly 14" G9 Mobile Workstation PC ENERGY STAR on HP websites and on http://www.energystar.gov. ²Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit www.epeat.net for more information.



Technical Specifications – Displays

DISPLAYS

14 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 eDP 1.2 w/o PSR 45 bent LCD Panel

Outline Dimensions (W x H)	307.590 x 199.550 (m	ax)
Active Area	301.590 X 188.500 (typ)	
Weight	300 (max)	
Diagonal Size	14	
Thickness	3.0 / 5.0 (max)	
Interface	eDP 1.2	
Surface Treatment	Anti-Glare	
Touch enabled	No	
Contrast Ratio	1000:1(typ)	
Refresh Rate	60 Hz	
Brightness	250 nits	
Pixel Resolution	Pitch	1920 x 1200 (WUXGA)
	Format	RGB Stripe
Backlight	WLED	
Color Gamut Coverage	NTSC 45%	
Color Depth	8 bits	
Viewing Angle	UWVA 89/89/89/89	
Low Blue Light	No	
Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.20 (max) / 2.70 (max	()
-		•

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 TOP eDP 1.2 w/o PSR 45 bent LCD Panel	Outline Dimensions (W \times H)	307.590 x 199.550 (ma	x)
	Active Area	301.590 x 188.500 (typ)	
	Weight	300 (max)	
	Diagonal Size	14	
	Thickness	3.0 / 5.0 (max)	
	Interface	eDP 1.2	
	Surface Treatment	Anti-Glare	
	Touch enabled	Yes	
	Contrast Ratio	1000:1(typ)	
	Refresh Rate	60 Hz	
	Brightness	250 nits	
	Pixel Resolution	Pitch	1920 x 1200 (WUXGA)
		Format	RGB
	Backlight	WLED	
	Color Gamut Coverage	NTSC 45%	
	Color Depth	8 bits	
	Viewing Angle	UWVA 89/89/89/89	
	Low Blue Light	No	



Technical Specifications – Displays

Power Consumption (W, 2.10 (max) / 2.60 (max) EBL@ 150nits max/ 200nits max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.



Technical Specifications – Displays

14 in WUXGA (1920 x
1200) Anti-Glare UWVA
WLED+LBL sRGB NB2X
400 eDP 1.4+PSR2 Low-
Power 100 bent LCD
Panel

Outline Dimensions (W × H)	307.590 x 199.550 (max	<)	
Active Area	301.590 X 188.500 (typ)		
Weight	210 (max)		
Diagonal Size	14		
Thickness	2.0 / 3.8 (max)		
Interface	eDP 1.4		
Surface Treatment	Anti-Glare		
Touch enabled	No		
Contrast Ratio	1000:1(typ)		
Refresh Rate	60 Hz		
Brightness	400 nits		
Pixel Resolution	Pitch	1920 x 1200 (WUXGA)	
	Format	RGB	
Backlight	WLED		
Color Gamut Coverage	sRGB 100%		
Color Depth	8 bits		
Viewing Angle	UWVA 89/89/89/89		
Low Blue Light	Yes		
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.29 (max) / 1.66 (max)		

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD	Outline Dimensions (W x H)	307.600 x 199.550 (typ)
	Active Area	301.680 x 188.500 (typ	o)
	Weight	238 (max)	
	Diagonal Size	14	
Panel	Thickness	2.2 / 3.9 (max)	
	Interface	eDP 1.3	
	Surface Treatment	Anti-Glare	
	Touch Enabled	No	
	Contrast Ratio	1500:1(typ)	
	Refresh Rate	60 Hz	
	Brightness	1000 nits	
	Pixel Resolution	Pitch	1920 x 1200 (WUXGA)
		Format	RGB
	Backlight	WLED	
	Color Gamut Coverage	sRGB 100%	
	Color Depth	8 bits	
	Viewing Angle	UWVA 85/85/85/85	



Technical Specifications – Displays

	Low Blue Light	Yes		
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	N/A		
	*All specifications represent t actual performance may vary		provided by HP's component manufacturers;	
-	Outline Dimensions (W x H)	307.594 x 199.546 (ma	x)	
1600) Anti-Glare UWVA LED DCI-P3 NB2X 500 eDP	Active Area	301.594 x 188.496 (typ))	
1.4+PSR2 100 120Hz	Weight	230g (max)		
bent LCD Panel	Diagonal Size	14		
	Thickness	2.0 / 3.8 (max)		
	Interface	eDP 1.4		
	Surface Treatment	Anti-Glare		
	Touch Enabled	No		
	Contrast Ratio	1200:1(typ)		
	Refresh Rate	120 Hz		
	Brightness	500 nits		
	Pixel Resolution	Pitch	3840 x 2160 (UHD)	
		Format	RGB Stripe	
	Backlight	WLED		
	Color Gamut Coverage	DCI-P3 100%		
	Delta E	<2		
	Color Depth	8 bits		
	Viewing Angle	UWVA 85/85/85/85		
	Low Blue Light	No		
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	6.4W max(150 NITS)		
	*All specifications represent t	he typical specifications	provided by HP's component manufacturers;	

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Technical Specifications – Storage

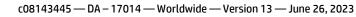
STORAGE AND DRIVES

JIONAGE AND DRI				
SSD 256GB 2280 PCIe-4x4 NVMe Three Layer Cell	4 Form Factor	M.2 2280		
	Capacity	256GB		
	NAND Type	TLC		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Weight	0.02 lb (10 g)		
	Interface	PCIe NVMe Gen4X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		4000 MB/s ±20%	2000 MB/s ±20%	
	Logical Blocks	500,118,192		
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	vient temp]	
	Features	Pyrite 2.0; TRIM; L1.2		
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for	
SSD 512GB 2280 PCIe-	Form Factor	M.2 2280		
4x4 NVMe Three Layer	Capacity	512GB		
Cell	NAND Type	TLC		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Weight	0.02 lb (10 g)		
	Interface	PCIe NVMe Gen4X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		6400 MB/s ±20%	3500 MB/s ±20%	
	Logical Blocks	1,000,215,215		
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]	
	Features	Pyrite 2.0; TRIM; L1.2		
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for	
SSD 1TB 2280 PCIe-4x4	Form Factor	M.2 2280		
NVMe Three Layer Cell	Capacity	1TB		
	NAND Type	TLC		
	71 -			
	Height	0.09 in (2.3 mm)		
	••			
	Height	0.09 in (2.3 mm)		
	Height Width	0.09 in (2.3 mm) 0.87 in (22 mm)		
	Height Width Weight	0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g)	Maximum Sequential Write	
	Height Width Weight Interface	0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Gen4X4	Maximum Sequential Write 5000 MB/s ±20%	
	Height Width Weight Interface	0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Gen4X4 Maximum Sequential Read	-	
	Height Width Weight Interface Performance	0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Gen4X4 Maximum Sequential Read 6400 MB/s ±20%	5000 MB/s ±20%	
	Height Width Weight Interface Performance Logical Blocks	0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Gen4X4 Maximum Sequential Read 6400 MB/s ±20% 2,000,409,264	5000 MB/s ±20%	



Technical Specifications – Storage

		formatted capacity is less. Up	= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for	
		system recovery software.		
SSD 2TB 2280 PCIe-4x4	Form Factor	M.2 2280		
NVMe Three Layer Cell	Capacity	2TB		
	NAND Type	TLC		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Weight	0.02 lb (10 g)		
	Interface	PCIe NVMe Gen4X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		6400 MB/s ±20%	5000 MB/s ±20%	
	Logical Blocks	4,000,797,360		
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]	
	Features	Pyrite 2.0; TRIM; L1.2		
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for	
256GB PCIe-4x4 2280	Form Factor	M.2 2280		
NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive	Capacity	256GB		
	NAND Type	TLC		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Weight	0.02 lb (10 g)		
	Interface	PCIe NVMe Gen4X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		4000 MB/s ±20%	2000 MB/s ±20%	
	Logical Blocks	500,118,192		
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]	
	Features	TCG Opal 2.0; TRIM; L1.2		
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for	
512GB PCIe-4x4 2280	Form Factor	M.2 2280		
NVME Self Encrypted	Capacity	512GB		
OPAL2 Three Layer Cell Solid State Drive	NAND Type	TLC		
John State Brive	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Weight	0.02 lb (10 g)		
	Interface	PCIe NVMe Gen4X4		
	Performance	Maximum Sequential Read 6400 MB/s ±20%	Maximum Sequential Write 3500 MB/s ±20%	
	Logical Blocks	1,000,215,215		
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]	
	Features	TCG Opal 2.0; TRIM; L1.2	-	



Technical Specifications – Storage

			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for
SSD 256GB 2280 PCIe	Form Factor	M.2 2280	
NVMe Value	Capacity	256 GB	
	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		1500 MB/s ±20%	750 MB/s ±20%
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	pient temp]
	Features	Pyrite 2.0; TRIM; L1.2	
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for
SSD 512GB 2280 PCIe	Form Factor	M.2 2280	
NVMe Value	Capacity	512 GB	
	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		1500 MB/s ±20%	750 MB/s ±20%
	Logical Blocks	1,000,215,215	
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	pient temp]
	Features	Pyrite 2.0; TRIM; L1.2	
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for



NETWORKING/COMMUNICATION

Intel AX211 Wi-Fi 6E +BT 5.3 M.2 160MHz CNVi World-Wide WLAN vPro	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n/ax • 2.402 - 2.482 GHz 802.11a/n/ac/ax • 4.9 - 4.95 GHz (Japan) • 5.15 - 5.25 GHz • 5.25 - 5.35 GHz • 5.47 - 5.725 GHz • 5.825 - 5.850 GHz • 5.955 - 6.415 GHz • 6.435 - 6.515 GHz • 6.535 - 6.875 GHz • 6.895 - 7.115 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 300Mbps 802.11ac : 1733Mbps 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum
		OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM , 1024QAM
	Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	
		Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points



Technical Specifications – Networking		
Output Power ²	 802.11g: +² 802.11a: +1 802.11n HT 802.11n HT 802.11n HT 802.11n HT 802.11n CVI 802.11ac VI 802.11ax HI 802.11ax HI 802.11ax HI 	17dBm minimum 16dBm minimum 17dBm minimum 20(2.4GHz) : +14dBm minimum 40(2.4GHz) : +13dBm minimum 20(5GHz) : +13dBm minimum 40(5GHz) : +13dBm minimum HT80(5GHz) : +10dBm minimum E40(2.4GHz) : +10dBm minimum E80(5GHz) : +10dBm minimum E160(5GHz) : +10dBm minimum
Power Consumption	 Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 Idle mode 50 mW (W Connected Standby Radio disabled 8 mW 	mW (WLAN Associated) LAN unassociated) 10mW
Power Management	ACPI and PCI Express c 802.11 compliant pow	compliant power management ver saving mode
Receiver Sensitivity ³	•802.11b, 1Mbps : -93 •802.11b, 11Mbps : -8 •802.11a/g, 6Mbps : - •802.11a/g, 54Mbps : •802.11a, MCS07 : -6 •802.11ac, MCS0(VHT •802.11ac, MCS9(VHT •802.11ac, MCS9(VHT •802.11ac, MCS9(VHT •802.11ac, MCS11(HE	3.5dBm maximum 94dBm maximum •86dBm maximum • -72dBm maximum 7dBm maximum
Antenna Type	display enclosure Two embedded dual b	a with spatial diversity, mounted in the and 2.4/5 GHz antennas are provided to the MIMO communications and Bluetooth
Form Factor	PCI-Express M.2 MiniC	ard
Dimensions	1. Type 2230 : 2.3 x 22 2. Type 1216: 1.67 x 1	2.0 x 30.0 mm
Weight	1. Type 2230 : 2.8g 2. Type 1216: 1.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non- operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio Of	f; LED Off – Radio ON



Technical Specifications – Networking

Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management	ETS 300 328, ETS 300 826
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range er, sold separately, and Windows 11 to function in the 6GHz band.

Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.



Intel AX211 Wi-Fi 6E +BT 5.3 M.2 160MHz CNVi World-Wide WLAN non- vPro		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n/ax • 2.402 - 2.482 GHz 802.11a/n/ac/ax • 4.9 - 4.95 GHz (Japan) • 5.15 - 5.25 GHz • 5.25 - 5.35 GHz • 5.47 - 5.725 GHz • 5.825 - 5.850 GHz • 5.955 - 6.415 GHz • 6.435 - 6.515 GHz • 6.535 - 6.875 GHz • 6.895 - 7.115 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 300Mbps 802.11ac : 1733Mbps 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum
		OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM , 1024QAM
	Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power ²	 802.11b : +17dBm minimum 802.11g : +16dBm minimum 802.11a : +17dBm minimum 802.11a : +17dBm minimum 802.11n HT20(2.4GHz) : +14dBm minimum 802.11n HT40(2.4GHz) : +13dBm minimum



Technical Specifications – Networking

	• 802.11n HT4 • 802.11ac VH • 802.11ac VH • 802.11ac VH • 802.11ax HE • 802.11ax HE	20(5GHz) : +14dBm minimum 40(5GHz) : +13dBm minimum IT80(5GHz) : +10dBm minimum IT160(5GHz) : +10dBm minimum 40(2.4GHz) : +12dBm minimum 280(5GHz) : +10dBm minimum
Power Consumption	• Transmit mode 2.0 W • Receive mode 1.6 W	mW (WLAN Associated) _AN unassociated)
	• Radio disabled 8 mW	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity ³ Antenna Type	 802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11n, MCS15 : -64dBm maximum 802.11ac, MCS0(VHT80) : -84dBm maximum 802.11ac, MCS9(VHT80) : -59dBm maximum 802.11ac, MCS9(VHT60) : -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum 	
		and 2.4/5 GHz antennas are provided to the MIMO communications and Bluetooth
Form Factor	PCI-Express M.2 MiniCa	ard
Dimensions	1. Type 2230 : 2.3 x 22 2. Type 1216: 1.67 x 12	
Weight	1. Type 2230 : 2.8g 2. Type 1216: 1.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non- operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OF	F; LED White – Radio ON
HP Integrated Module with Blueto	oth 4.0/4.1/4.2/5.0/5.	1/5.2/5.3 Wireless Technology
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/ BLE : 0~39 (2 MHz/CH)	





Data Rates and Throughput Transmit Power	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth douice with a maximum transmit power of + 0.5 dBm for BD and
	device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range

Security & Manageability

Intel[®] vPro[™] support with appropriate Intel[®] chipset components

* Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, and Windows 11 to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.



Intel [®] 5G Solution 5000	
Technology/Operating bands*	WCDMA/HSPA+ operating bands:
Danus	Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
	Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
	Band 4: 17 10 to 17 33 Mil2 (0L), 21 10 to 21 33 Mil2 (0L) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
	Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
	LTE FDD/TDD operating bands:
	Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
	Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
	Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
	Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
	Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
	Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
	Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
	Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)
	Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)
	Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)
	Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL) Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)
	Band 19: 830 to 845 MHz (UL), 850 to 875 MHz (DL)
	Band 19: 830 to 843 MHz (UL), 873 to 830 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
	Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
	Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)
	Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
	Band 29: 717 to 728 MHz (DL)
	Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)
	Band 32: 1452 to 1496 MHz (DL)
	Band 34: 2010 to 2025 MHz (UL/DL)
	Band 38: 2570 to 2620 MHz (UL/DL)
	Band 39: 1880 to 1920 MHz (UL/DL)
	Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL)
	Band 41: 2496 to 2690 MHZ (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL)
	Band 43: 3400 to 3800 MHZ (UL/DL)
	Band 46: 5150 to 5925 MHZ (DL)
	Band 48: 3550 to 3700 MHZ (UL/DL)
	Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
	n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
	n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
	n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
	n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
	n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
	n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
	n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
	n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
	n38: 2570 to 2620 MHz (UL/DL)
	n40: 2300 to 2400 MHz (UL/DL)
	n41: 2496 to 2690 MHz (UL/DL)
	n48: 3550 to 3700 MHZ (UL/DL)
	n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
	n77: 3300 to 4200 MHz (UL/DL)
	n78: 3300 to 3800 MHz (UL/DL)
	n79: 4400 to 5000 MHz (UL/DL)

Wireless protocol standards	5GNR Air Interface 3GPP Rel15 5G NR sub-6 LTE Rel14 20 layers and 2 Gbps downlink (DL) throughput – 4 × 4 MIMO across 5x CA 200 Mbps/uplink (UL) throughput – 40 MHz ULCA and 256 QAM WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone, A-GPS (MS-A, MS-B)
GPS bands	GPS: L1 (1575.42MHz) GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)
Maximum data rates	SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps 5G NSA sub 6G : DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19, (DL : 1.6 Gbps) ue-CategoryUL 13 , (UL: 150Mbps) DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)
Maximum output power	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm NR: 23 dBm in all band except n41, n77, n78 and n79 LTE n41, n77, n78 and n79 HPUE = 26dBm HSPA+: 23.5 dBm
Maximum power consumption	5G Sub 6 : 2500 mA LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	М.2, 3042-S3 Кеу В
Weight	8 g
Dimensions (Length x Width x Thickness)	52 mm × 30 mm × 2.6 mm
MIکم	Support

eSIM Support

* Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

Intel® XMM™ 7560 R+ LTE-Advanced Pro

Technology/Operating bands*	 FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz



Technical Specifications – Networking

Wireless protocol standards	3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
GPS Bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
Maximum Data Rates	LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
Maximum Output Power	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm
Maximum Power Consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	6 g
Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm
eSIM	Support

*4G LTE module is optional, must be configured at the factory, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Near Field Communications Controller (optional)

Dimensions (L x W	
x H)	Module 25 mm by 10 mm by 2.0 mm
Chipset	NPC100
System interface	12C
NFC RF standards	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
NFC Forum Support	Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2
Reader (PCD-VCD) Mode(1)	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards
Card Emulation (PICC- VICC) Mode(1)	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa
Frequency	13.56 MHz



NFC Modes Supported	Reader/Writer, Peer-to-Peer		
Raw RF Data Rates	106, 212, 424, 848 kbps		
Operating temperature	0°C to 70°C		
Storage temperature	-20°C to 125°C		
Humidity	10-90% operating 5-95% non-operati	ng	
Supply Operating voltage I/O Voltage	4.35 to 5.25 Volts 1.8V or 3.3V	-	
Power Consumption	Booster enable,	VBAT= 3.3V,	
	VCC_BOOST = 5V) Mode Power Consumption, Typical	Polling Detected Test Tag Type 1 Detected Test Tag Type 2 Detected Test Tag Type 3 Detected Test	7.3 mA Total 283.8 mA Net Module 236.8 mA Total 288.8 mA Net Module 241.8 mA Total 287.7 mA Net Module 240.7 mA Total 282.3 mA Net Module 235.3 mA
Antenna	Antenna connector external to module		connector FPC. Antenna matching is

AUDIO

HD Stereo Codec Audio I/O Ports	Realtek ALC3315 Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	Cirrus Logic High-Efficiency Boosted Class D Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio. Following MSFT Behaviour
Sampling	DAC: 44.1k/48kHz ADC: 48kHz
Wavetable Syntheses	
Analog Audio # of Channels on Line- Out	Support 3.5mm Headset: CTIA only and Headphone-out
Internal Speaker	Yes

FINGERPRINT READER

Synaptics FS7604	
Capacitive	
363DPI	
7.4x6mm sensor area	
<1%	
1:50K FAR	

Technical Specifications – Networking

Mobile Voltage Operation Mobile Voltage Operation: 3.0V to 3.6V			
Operating Temperature	Operating Temperature: 0~60°C		
Current Consumption Image	Current Consumption Image: 100mA Max		
Low Latency Wait For Finger	Low Latency Wait For Finger: 260 uA		
Capture Rate	Capture Rate: <30msec per image		
ESD Resistance	ESD Resistance: IEC 61000-4-2 4B (+/-15KV)		
Detection Matrix	Detection Matrix: 363 dpi / 7.4x6mm sensor area		

POWER

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.8m		88x53.5x21mm	
	Weight Input	unit: 220g +/- 10g Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A
			86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A
		Input frequency range	47 ~ 63 Hz
		Input AC current	1.6 A at 90 VAC and maximum load
	Output	Output power	65W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	5ms at 115 Vac input
		Output current limit	<8.0A
	Connector	C6	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	5% to 95%
		Storage Humidity	5% to 95%
	EMI and Safety Certifications	* Worldwide safety standa 1 and/or EN62368-1, UL6 Agency approvals - C-UL-I B, CISPR32 Class B, CCC, N	e with LVD and EMC directives ards - IEC60950-1 and/or IEC62368-1, EN60950- 0950-1 and/or UL62368-1 , Class1, SELV; US, NORDICS, DENAN, EN55032 Class B, FCC Class OM-001 NYCE. urs at 25°C ambient condition.



Technical Specifications – Power

AC Adapter 65 Watt nPFC Dimensions 90.0mm*51.0mm*28.5mm Standard USB type C Weight 250g +/-10%		n	
Straight 1.8m	Weight	250g +/-10%	· · · · · · · · · · · · · · · · · · ·
-	Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V : 81.5% 9V : 86.7% 12V : 88% 15V : 88% 20V : 89%
		Input frequency range	47 ~ 63 Hz
		Input AC current	Max. 1.6 A at 90 Vac
	Output	Output power	5V/15W 9V/27W 12V/60W 15V/60W 20V/65W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	5ms at 115 Vac input
		Output current limit	<8.0A
	Connector	C6	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	* Worldwide safety standa 1 and/or EN62368-1, UL60 Agency approvals - C-UL-L B, CISPR32 Class B, CCC, N	with LVD and EMC directives ords - IEC60950-1 and/or IEC62368-1, EN60950- 0950-1 and/or UL62368-1 , Class1, SELV; JS, NORDICS, DENAN, EN55032 Class B, FCC Class OM-001 NYCE. ors at 25°C ambient condition.
HP 3-cell Long Life Li-Ion	Dimensions (H x W x L)	251.8*70.3*6.82mm (9.91	*2.77*0.27 inch)
(51 WHr)	Weight	0.229kg +/- 10g(0.505 lb)	
	Cells/Type	3cell Lithium-Ion Polymer	cell / 566075
	Energy	Voltage	11.58V
		Amp-hour capacity	4.431Ah
		Watt-hour capacity	51.3Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 140° F (-10° to 60° C)
	Fuel Gauge LED	NA	
	Warranty	Follow product spec	
	Optional Travel Battery Available	No	





Technical Specifications – Power

*Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.



ENVIRONMENTAL DATA

Eco-Label Certifications & declarations	 may be labeled with one or mor IT ECO declaration US ENERGY STAR[®] US Federal Energy Man EPEAT[□] Gold registered status in your country. TCO Certified China Energy Conserva 	agement Program (FEMP) in the United States. See http://	www.epeat.net for registration
Sustainable Impact Specifications			
System Configuration		nergy Consumption and Declare Typically Configured Notebook".	d Noise Emissions data for the
Energy Consumption			
(in accordance with US ENERGY STAR® test method)		230VAC, 50Hz	100VAC, 50Hz
STAR [®] test method)	7 115VAC, 60Hz 5.88 W	230VAC, 50Hz 6.17 W	100VAC, 50Hz 5.92 W
-	115VAC, 60Hz		
STAR [®] test method) Normal Operation (Short idle)	115VAC, 60Hz 5.88 W	6.17 W	5.92 W
STAR® test method) Normal Operation (Short idle) Normal Operation (Long idle)	115VAC, 60Hz 5.88 W 1.66 W	6.17 W 1.85 W	5.92 W 1.76 W
STAR® test method) Normal Operation (Short idle) Normal Operation (Long idle) Sleep	115VAC, 60Hz 5.88 W 1.66 W 1.66 W 0.46 W NOTE: Energy efficiency data listed is f model family. HP computers ma applicable U.S. Environmental P computers. If a model family do energy efficiency data listed is f	6.17 W 1.85 W 1.85 W	5.92 W 1.76 W 1.76 W 0.41 W broduct if offered within the go are compliant with the STAR [®] specifications for bliant configurations, then uring a hard disk drive, a high
STAR® test method) Normal Operation (Short idle) Normal Operation (Long idle) Sleep	115VAC, 60Hz 5.88 W 1.66 W 1.66 W 0.46 W NOTE: Energy efficiency data listed is f model family. HP computers ma applicable U.S. Environmental P computers. If a model family do energy efficiency data listed is f	6.17 W 1.85 W 1.85 W 0.48 W or an ENERGY STAR [®] compliant p irked with the ENERGY STAR [®] Log rotection Agency (EPA) ENERGY S es not offer ENERGY STAR [®] comp or a typically configured PC featu	5.92 W 1.76 W 1.76 W 0.41 W broduct if offered within the go are compliant with the STAR [®] specifications for bliant configurations, then uring a hard disk drive, a high
STAR® test method) Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off	115VAC, 60Hz 5.88 W 1.66 W 1.66 W 0.46 W NOTE: Energy efficiency data listed is f model family. HP computers ma applicable U.S. Environmental P computers. If a model family do energy efficiency data listed is f efficiency power supply, and a N	6.17 W 1.85 W 1.85 W 0.48 W or an ENERGY STAR® compliant p inked with the ENERGY STAR® Log rotection Agency (EPA) ENERGY S es not offer ENERGY STAR® comp or a typically configured PC features ficrosoft Windows® operating systems	5.92 W 1.76 W 1.76 W 0.41 W product if offered within the go are compliant with the STAR® specifications for bliant configurations, then uring a hard disk drive, a high stem.
STAR® test method) Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Heat Dissipation*	115VAC, 60Hz 5.88 W 1.66 W 1.66 W 0.46 W NOTE: Energy efficiency data listed is f model family. HP computers ma applicable U.S. Environmental P computers. If a model family do energy efficiency data listed is f efficiency power supply, and a N	6.17 W 1.85 W 1.85 W 0.48 W or an ENERGY STAR® compliant p inked with the ENERGY STAR® Log rotection Agency (EPA) ENERGY S es not offer ENERGY STAR® comp or a typically configured PC featu ficrosoft Windows® operating sys	5.92 W 1.76 W 1.76 W 0.41 W broduct if offered within the go are compliant with the STAR® specifications for bliant configurations, then uring a hard disk drive, a high stem. 100VAC, 50Hz
STAR® test method) Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Heat Dissipation* Normal Operation (Short idle)	115VAC, 60Hz 5.88 W 1.66 W 1.66 W 0.46 W NOTE: Energy efficiency data listed is f model family. HP computers ma applicable U.S. Environmental P computers. If a model family do energy efficiency data listed is f efficiency power supply, and a N 115VAC, 60Hz 20.1 BTU/hr	6.17 W 1.85 W 1.85 W 0.48 W or an ENERGY STAR® compliant p rked with the ENERGY STAR® Log rotection Agency (EPA) ENERGY S es not offer ENERGY STAR® comp or a typically configured PC featu licrosoft Windows® operating system 230VAC, 50Hz 21.1 BTU/hr	5.92 W 1.76 W 1.76 W 0.41 W broduct if offered within the go are compliant with the 5TAR® specifications for bliant configurations, then uring a hard disk drive, a high stem. 100VAC, 50Hz 20.2 BTU/hr

***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured – Idle Fixed Disk – Random writes		Sound Power (L _{wAd} , bels) 2.9 3.6	Sound Pressure (L _{pAm} , decibels) 21.6 28.5
Optical Drive – Sequential reads		4.1	33.2
Longevity and Upgrading	This product can		nding its useful life by several years. Upgradeable
Longevity and opgrading	features and/or	components contained in th	
Additional Information	directiv This HP Equipm This pro Drinking This pro www.ep Plastics and ISO	re - 2011/65/EC. P product is designed to comp nent (WEEE) Directive – 2002 oduct is in compliance with C g Water and Toxic Enforceme oduct is in compliance with th peat.net s parts weighing over 25 gran 01043.	alifornia Proposition 65 (State of California; Safe
Packaging Materials	External:	PAPER/Corrugated	269 g
		PAPER/Paper	3 g
		PAPER/Molded Pulp	108 g
	Internal:	PLASTIC/Polyethylene low	_
	The plastic pack	kaging material contains at l	
	The corrugated	paper packaging materials (contains at least 59.1% recycled content.
RoHS Compliance	the restrictions i to our products	in the European Union (EU) R	ions. We were among the first companies to extend estriction of Hazardous Substances (RoHS) Directive SE. HP has contributed to the development of a, India, and Vietnam.
	wide elimination substances—inc	n of substances of concern. V	vs play an important role in promoting industry- Ve have supported the inclusion of additional n phthalates—in future RoHS legislation that :s.
	requirements fo	r virtually all relevant produ	orldwide compliance with the new EU RoHS cts by July 2013, and we will continue to extend the restricted substances as regulations continue to
	To obtain a copy	of the HP RoHS Compliance	Statement, see HP RoHS position statement.
Material Usage	(refer to the HP	General Specification for the	owing substances in excess of regulatory limits Environment at p/environment/supplychain/gen_specifications.html



):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and
RecyclingHP offers end-of-life HP product return and recycling programs in many geographic areas. To
recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest
HP sales office. Products returned to HP will be recycled, recovered or disposed of in a
responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.



HP Inc. Corporate Environmental Information	For more information about HP's commitment to the environment:			
	Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf			
Footnotes	 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials. 			

Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA,2E6V0AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
Docking station	HP 120W G2 Dock	2UK37AA
	HP 120W G2 Dock w/Audio	3YE87AA
	HP 230W G2 Dock w/Combo Cable	3TR87AA
	HP USB-C 120W G5 Dock	5TW10AA
	HP 120W Thunderbolt Dock	6HP48AA
	HP USB-C Dock G5	26D32AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP TB Dock 120W G2 Cable	3XB94AA
	HP TB Dock 230W G2 Cable	3XB95AA
	HP TB Dock G2 Combo Cable	3XB96AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4JOG4AA
Hub	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB to Gigabit RJ45 Adapter	N7P47AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA



Options and Accessories (sold separately and availability may vary by country)

Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Memory	HP 8GB DDR5 4800 SODIMM Memory	5S4C3AA
	HP 16GB DDR5 4800 SODIMM Memory	5S4C4AA
	HP 32GB DDR5 4800 SODIMM Memory	5S4COAA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto AC Power Adapter	5TQ76AA
	HP 45W USB-C G2 AC Power Adapter	1HE07AA
	HP 45W USB-C LC AC Power Adapter	1MZ01AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
	HP 65W Gallium Nitride USB-C Laptop Charger	600Q7AA
	HP 65W Gallium Nitride USB-C Laptop Charger	600Q8AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA



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Date of change:	Version History:		Description of change:
May 20, 2022	From v1 to v2	Changed	POWER section
May 31, 2022	From v2 to v3	Changed	DRIVE CONTROLLERS section
June 29, 2022	From v3 to v4	Changed	SOFTWARE AND SECURITY section
August 10, 2022	From v4 to v5	Changed	Options and Accessories section
September 12, 2022	From v5 to v6	Changed	At A Glance section
September 15, 2022	From v6 to v7	Removed	Tile App for Software
November 18, 2022	From v7 to v8	Changed	Display section
December 7, 2022	From v8 to v9	Changed	Format
February 6, 2023	From v9 to v10	Changed	NETWORKING/COMMUNICATION
March 13, 2023	From v10 to v11	Changed	NETWORKING/COMMUNICATIONS section
April 12, 2023	From v11 to v12	Changed	Displays section
June 26, 2023	From v12 to v13	Changed	POWER and SYSTEM UNIT sections



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